



# **Dual N-Channel 40-V MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
40	0.016 at V <sub>GS</sub> = 10 V	8	56			
40	0.019 at V <sub>GS</sub> = 4.5 V	8	56			

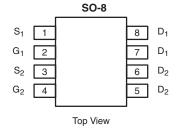
## FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % R<sub>q</sub> Tested
- UIS Tested



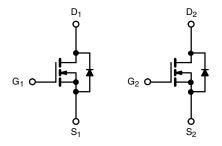
#### **APPLICATIONS**

• CCFL Inverter



Ordering Information: Si4904DY-T1-E3 (Lead (Pb)-free)

Si4904DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A =$	= 25 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	40	v		
Gate-Source Voltage		V <sub>GS</sub>	± 16	v	
	T <sub>C</sub> = 25 °C		8		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	ı_ l	8	1	
Continuous Brain Current (1) = 130 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		6.5 <sup>b, c</sup>		
Pulsed Drain Current (10 μs Pulse Width)		I <sub>DM</sub>	20	A	
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C	T <sub>C</sub> = 25 °C	2.7	A	
Source-Drain Current blode Current	T <sub>A</sub> = 25 °C	'S	1.6 <sup>b, c</sup>	ı	
Pulsed Source-Drain Current		I <sub>SM</sub>	20		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20		
Single Pulse Avalanche Energy	L=0.1111H	E <sub>AS</sub>	20		
	T <sub>C</sub> = 25 °C		3.25	w	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	$P_D$	2.10		
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	' D	2.0 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1.25 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	45	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady-State	$R_{thJF}$	29	38	] 5/**		

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 120 °C/W.

# **Si4904DY**

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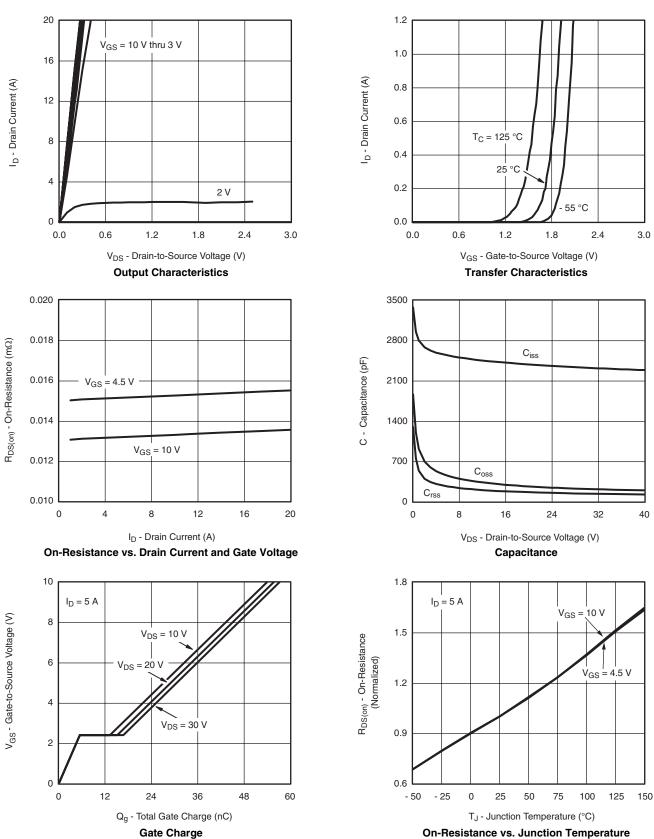
SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				I	T		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, } I_D = 250  \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		40		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 4.8			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	8.0		2.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V			1	1 10 μA	
Zero date voltage Diam Guirent		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
D : 0	D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		0.013	0.016	Ω	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4 A		0.015	0.019		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A		23		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>	N. C.		2390			
Output Capacitance	C <sub>oss</sub>	N-Channel $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ MHz}$		270		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	VDS - 20 V, VGS - 0 V, ID - 1 IVII IZ		165		1	
Total Cata Charge		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		56	85		
Total Gate Charge	Qg			26	40		
Gate-Source Charge	Q <sub>gs</sub>	N-Channel $V_{DS} = 20 \text{ V, } V_{GS} = 4.5 \text{ V, } I_{D} = 5 \text{ A}$		5.5		nC	
Gate-Drain Charge	$Q_{gd}$	T <sub>DS</sub> = 20 1, 1 <sub>GS</sub> = 1.0 1, 1 <sub>D</sub> = 0 1.		9.7			
Gate Resistance	$R_{g}$	f = 1 MHz		2.6	4.0		
Turn-On Delay Time	t <sub>d(on)</sub>			15	23		
Rise Time	t <sub>r</sub>	N-Channel		20	30	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 20 V, $R_L$ = 4 $\Omega$ $I_D \cong 5$ A, $V_{GEN}$ = 4.5 V, $R_q$ = 1 $\Omega$		56	85	1	
Fall Time	t <sub>f</sub>			10	15	1	
Turn-On Delay Time	t <sub>d(on)</sub>			88	135	ns	
Rise Time	t <sub>r</sub>	N-Channel		117	180	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 20 V, $R_L$ =4 $\Omega$ $I_D \cong 5$ A, $V_{GEN}$ = 4.5 V, $R_q$ = 1 $\Omega$		62	95	1	
Fall Time	t <sub>f</sub>			19	30	1	
<b>Drain-Source Body Diode Characterist</b>	cs					_	
Continuous Source-Drain Diode Current	Is	T <sub>C</sub> = 25 °C			2.7	_	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				20	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1.5 A		0.69	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			62	95	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	N-Channel		62	95	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 2 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		26			
Reverse Recovery Rise Time	t <sub>b</sub>			36		nS	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



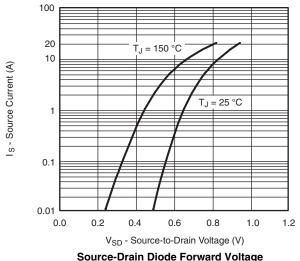


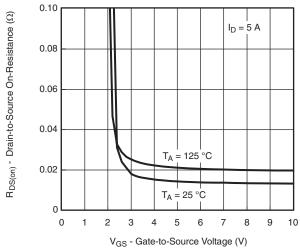
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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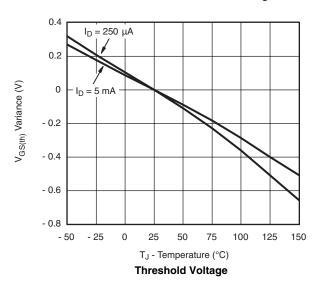
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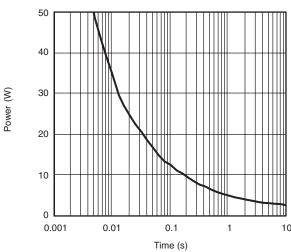




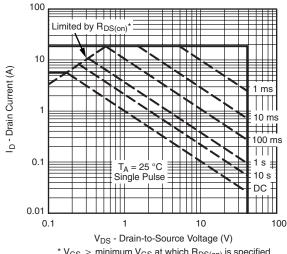
Source-Drain Diode Forward Voltage







Single Pulse Power, Junction-to-Ambient

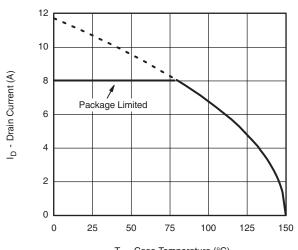


\*  $V_{GS} > \mbox{minimum} \ V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

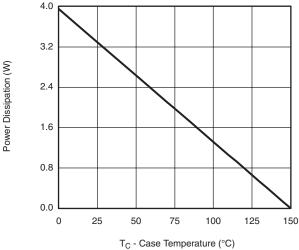


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

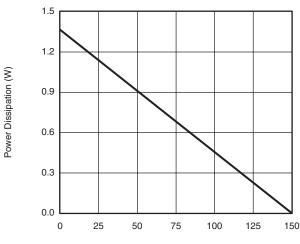


T<sub>C</sub> - Case Temperature (°C)









T<sub>A</sub> - Ambient Temperature (°C) Power Derating, Junction-to-Ambient

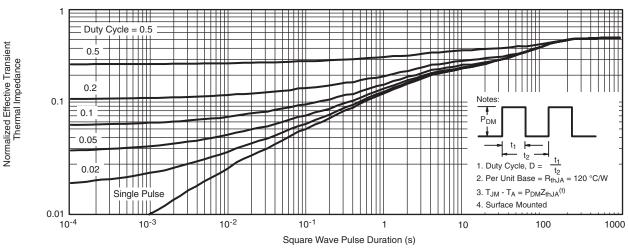
Power Derating, Junction-to-Foot

<sup>\*</sup> The power dissipation PD is based on TJ(max) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

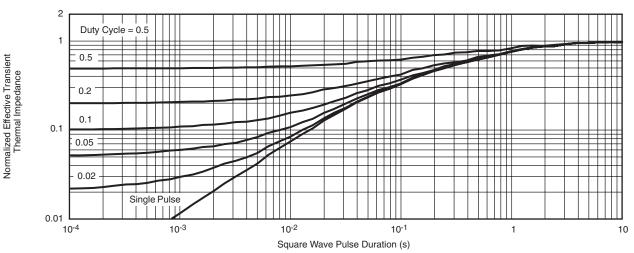
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



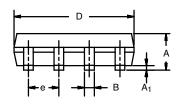
Normalized Thermal Transient Impedance, Junction-to-Case

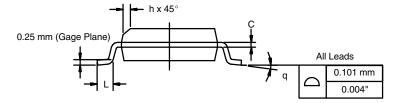
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	) BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

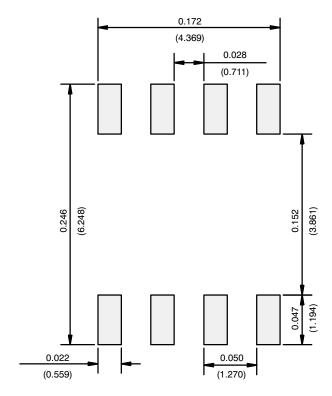
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

# LON NOTE



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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